

60 V, 1 A PNP medium power transistors

Rev. 10 — 30 May 2024

**Product data sheet** 

### 1. General description

PNP medium power transistors in a SOT223 (SC-73) Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- High current
- Three current gain selections
- High power dissipation capability
- AEC-Q101 qualified

### 3. Applications

- Linear voltage regulators
- High-side switches
- Battery-driven devices
- Power management
- MOSFET drivers
- Amplifiers

### 4. Quick reference data

#### Table 1. Quick reference data

 $T_{amb}$  = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-	-60	V	
I <sub>C</sub>	collector current			-	-	-1	А	
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	-	-2	А	
h <sub>FE</sub>	DC current gain							
	BCP52	$V_{CE}$ = -2 V; I <sub>C</sub> = -150 mA T <sub>amb</sub> = 25 °C	[1]	63	-	250		
	BCP52-10		[1]	63	-	160		
	BCP52-16		[1]	100	-	250		

[1] pulsed;  $t_p \le 300 \ \mu s; \ \delta \le 0.02$ 



# 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base	4	C
2	С	collector		
3	E	emitter		B
4	С	collector		É
				sym028

# 6. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
<u>BCP52</u>	-	plastic, surface-mounted package with increased heatsink;	<u>SOT223</u>				
BCP52-10		4 leads; 2.3 mm pitch; 6.5 mm x 3.5 mm x 1.65 mm body					
BCP52-16							

# 7. Marking

Table 4. Marking						
Type number	Marking code					
BCP52	BCP52					
BCP52-10	BCP52/10					
BCP52-16	BCP52/16					

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

T<sub>amb</sub> = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter		-	-60	V
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-60	V
V <sub>EBO</sub>	emitter-base voltage	open collector		-	-5	V
I <sub>C</sub>	collector current				-1	А
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	-2	А
I <sub>B</sub>	base current			-	-0.3	А
I <sub>BM</sub>	peak base current	single pulse; t <sub>p</sub> ≤ 1 ms		-	-0.3	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	0.65	W
			[2]	-	1.00	W
			[3]	-	1.35	W
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.

[1] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>. Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>. [2] [3] 006aac674 1.5 (1) P<sub>tot</sub> (W) (2) 1.0 (3) 0.5 0.0 125 175 T<sub>amb</sub> (°C) . -75 -25 25 75 (1) FR4 PCB, single-sided copper, mounting pad for collector 6 cm<sup>2</sup> (2) FR4 PCB, single-sided copper, mounting pad for collector 1 cm<sup>2</sup> (3) FR4 PCB, single-sided copper, standard footprint Fig. 1. Power derating curves

### 9. Thermal characteristics

#### Table 6. Thermal characteristics

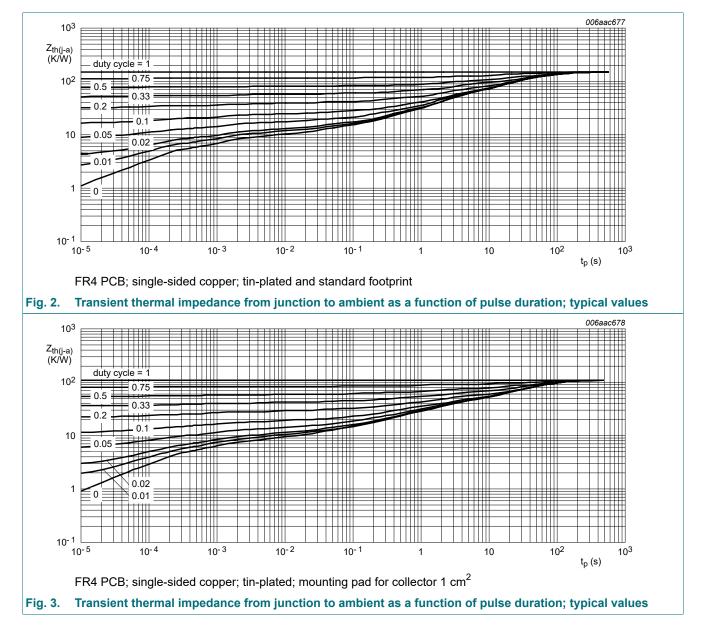
 $T_{amb}$  = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1]	-	-	192	K/W
			[2]	-	-	125	K/W
			[3]	-	-	93	K/W
R <sub>(j-sp)</sub>	thermal resistance from junction to solder point			-	-	16	K/W

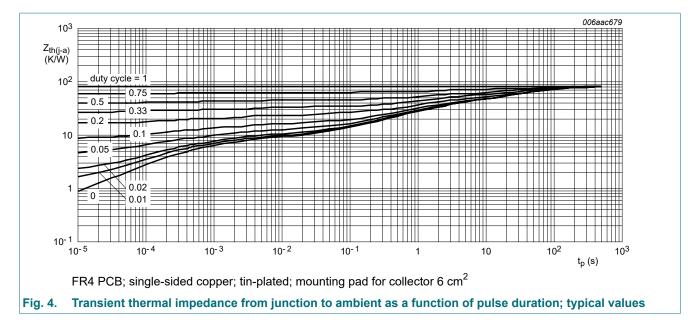
[1] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.



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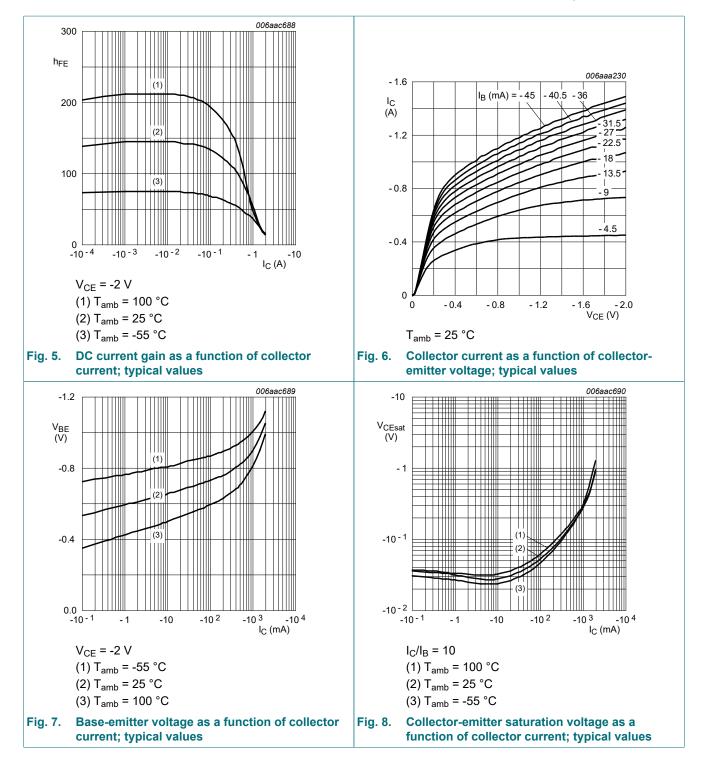
### **10. Characteristics**

#### Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit		
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB}$ = -30 V; I <sub>E</sub> = 0 A T <sub>amb</sub> = 25 °C		-	-	-100	nA		
		V <sub>CB</sub> = -30 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C		-	-	-10	μA		
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = -5 V; I <sub>C</sub> = 0 A T <sub>amb</sub> = 25 °C		-	-	-100	nA		
h <sub>FE</sub>	DC current gain								
	BCP52	$V_{CE}$ = -2 V; I <sub>C</sub> = -5 mA T <sub>amb</sub> = 25 °C	[1]	63	-	-			
		V <sub>CE</sub> = -2 V; I <sub>C</sub> = -150 mA T <sub>amb</sub> = 25 °C		63	-	250			
		V <sub>CE</sub> = -2 V; I <sub>C</sub> = -500 mA T <sub>amb</sub> = 25 °C		40	-	-			
	BCP52-10	$V_{CE}$ = -2 V; I <sub>C</sub> = -5 mA T <sub>amb</sub> = 25 °C	[1]	63	-	-			
		V <sub>CE</sub> = -2 V; I <sub>C</sub> = -150 mA T <sub>amb</sub> = 25 °C		63	-	160			
		V <sub>CE</sub> = -2 V; I <sub>C</sub> = -500 mA T <sub>amb</sub> = 25 °C		40	-	-			
	BCP52-16	$V_{CE}$ = -2 V; I <sub>C</sub> = -5 mA T <sub>amb</sub> = 25 °C	[1]	63	-	-			
		V <sub>CE</sub> = -2 V; I <sub>C</sub> = -150 mA T <sub>amb</sub> = 25 °C		100	-	250			
		V <sub>CE</sub> = -2 V; I <sub>C</sub> = -500 mA T <sub>amb</sub> = 25 °C		40	-	-			
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = -500 mA; I <sub>B</sub> = -50 mA T <sub>amb</sub> = 25 °C	[1]	-	-	-0.5	V		
V <sub>BE</sub>	base-emitter voltage	$V_{CE} = -2 V; I_C = -500 mA$ $T_{amb} = 25 °C$	[1]	-	-	-1	V		
C <sub>c</sub>	collector capacitance	$V_{CB} = -10 \text{ V}; \text{ I}_{E} = \text{ i}_{e} = 0 \text{ A}; \text{ f} = 1 \text{ MHz}$ $T_{amb} = 25 \text{ °C}$		-	15	-	pF		
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = -5 V; I <sub>C</sub> = -50 mA; f = 100 MHz T <sub>amb</sub> = 25 °C		-	145	-	MHz		

[1] pulsed;  $t_p \le 300 \ \mu s; \delta \le 0.02$ 

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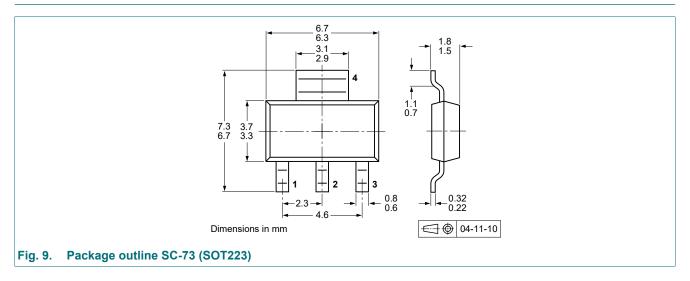
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### **11. Test information**

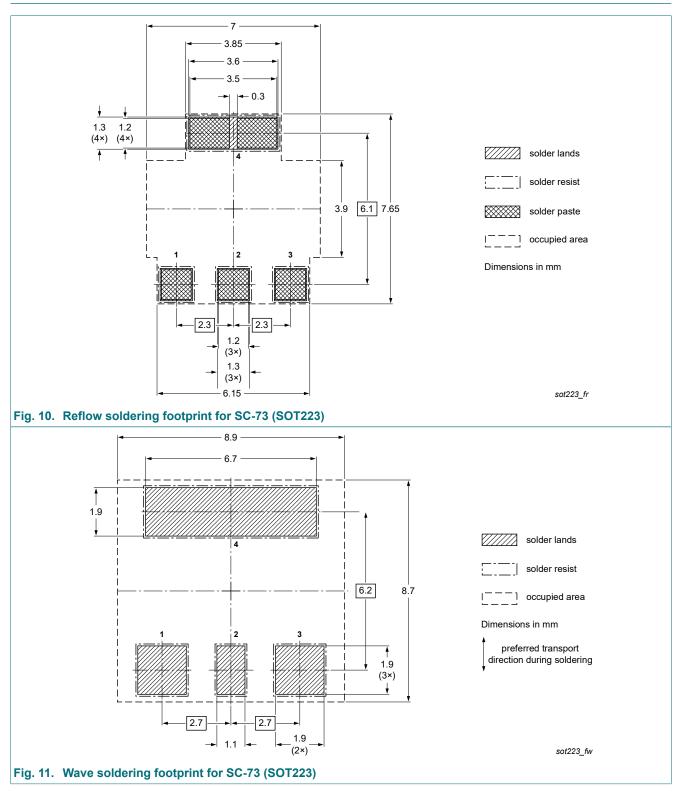
### 11.1. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

### 12. Package outline



### 13. Soldering



# 14. Revision history

Table 8. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
BCP52_SER v.10	20240530	Product data sheet	-	BCP52_BCX52_BC52PA v.9
Modifications:		arated into 3 data sheets g information" removed		
BCP52_BCX52_BC52PA v.9	20111018	Product data sheet	-	BCP52_BCX52 v.8
BCP52_BCX52 v.8	20080225	Product data sheet	-	BC638_BCP52_BCX52 v.7
BC638_BCP52_BCX52 v.7	20070626	Product data sheet	-	BC638_BCP52_BCX52 v.6
BC638_BCP52_BCX52 v.6	20060329	Product data sheet	CPCN200405 029	BC636_638_640 v.5 BCP51_52_53 v.5 BCX51_52_53 v.4
BC636_638_640 v.5	20041011	Product specification	-	BCX51_52_53 v.5
BCX51_52_53 v.5	20030206	Product specification	-	BCX51_52_53 v.4
BCX51_52_53 v.4	20011010	Product specification	-	BCX51_52_53 v.3

### 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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BCP52\_SER

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